**Annex II.**

**Letter of Commitment**

**Participation in an international University-Industry Chair**

**in the field of semiconductors and microelectronics**

D/Dª\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_, ID number \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_ address for notifications at \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_, on behalf of the company \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_ VAT \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_

In addition to the application for support for the creation of an international University-Industry Chair in the field of semiconductors and microelectronics in order to participate in the call included in the Order ETD/832/2023 of 18 July, by which the regulatory bases are established and the grant of aid for the creation of university-industry chairs (Chip Chairs), aimed at research and development in the area of microelectronics, for the dissemination of knowledge and training within the framework of the European Recovery, Transformation, and Resilience Plan, -financed by the European Union- NextGenerationEU,

I hereby declare that in the event that the entity I represent is selected by the University of Granada as one of the entities of the productive sector to be part of the application for an international University-Industry Chair in the field of semiconductors and microelectronics, we undertake to:

1. to sign an agreement, jointly with the University of Granada, in accordance with the indications of article 11.7 of the previous order,
2. to make a financial contribution to the Chair of \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_€ under the terms established in the agreement. This contribution is contingent upon the University of Granada being declared the beneficiary of the aid by means of the resolution of concession of the aforementioned call for applications.

I hereby sign this letter on [\_\_\_\_\_\_\_\_\_\_\_\_\_\_ or electronic signature].